

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	323	capacitor and (conductive plate) and resin and @ad<"20020907"	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 07:13
2	BRS	L2	279	capacitor and (conductive filler) and resin and @ad<"20020907"	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 07:13
3	BRS	L3	0	molded capacitor plate and @ad<"20010907"	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 07:42
4	BRS	L4	0	(molded capacitor plate) and @ad<"20010907"	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 07:43
5	BRS	L5	0	(moldable capacitor plate) and @ad<"20010907"	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 07:43

	Type	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L6	0	(moldable or moldable) with (capacitor plate) and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:43
7	BRS	L7	0	(moldable or moldable) same (capacitor plate) and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:44
8	BRS	L8	0	(filled resin capacitor plate) and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:44
9	BRS	L9	0	(filled resin) with (capacitor plate) and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:45
10	BRS	L10	0	(filled resin) same (capacitor plate) and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:45

	Type	L #	Hits	Search Text	DBs	Time Stamp
11	BRS	L11	0	((filled resin) same (capacitor plate)) and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:45
12	BRS	L12	3	((conductive filler) same (capacitor plate)) and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:46
13	BRS	L13	3	((conductive filler) with (capacitor plate)) and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:54
14	BRS	L14	284	361/305.ccls. and @ad<"20010907"	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 08:39
15	BRS	L15	64	14 and resin	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	2004/12/09 07:55

	Type	L #	Hits	Search Text	DBs	Time Stamp
16	BRS	L16	426	361/303.ccls. and @ad<"20010907"	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 08:52
17	BRS	L17	89	16 and resin	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 08:40
18	BRS	L18	25	361/301.1.ccls. and @ad<"20010907" and resin	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 08:57
19	BRS	L19	71	257/532.ccls. and @ad<"20010907" and resin	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 09:19
20	BRS	L20	10	438/393.ccls. and @ad<"20010907" and resin	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 10:22

	Type	L #	Hits	Search Text	DBs	Time Stamp
21	BRS	L21	273	(conductive filler) and (metal (plate or plating)) and @ad<"20010907"	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 10:35
22	BRS	L22	82	21 and fiber	US- PGPUB; USPAT; EPO; JPO; IBM_TD B	2004/12/09 10:36